

# PATENT ASSIGNMENT

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Anthony J. Saliba	07/21/2000
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	STC, L.L.C.
<b>Street Address:</b>	311 South Wacker Drive
<b>City:</b>	Chicago
<b>State/Country:</b>	ILLINOIS
<b>Postal Code:</b>	60606
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13038253
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(312)775-8100
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	312-775-8000
<b>Email:</b>	mhmpto@mcandrews-ip.com
<b>Correspondent Name:</b>	MCANDREWS HELD & MALLOY, LTD
<b>Address Line 1:</b>	500 WEST MADISON STREET
<b>Address Line 2:</b>	SUITE 3400
<b>Address Line 4:</b>	CHICAGO, ILLINOIS 60661
<b>ATTORNEY DOCKET NUMBER:</b>	12778US05
<b>NAME OF SUBMITTER:</b>	Joseph M. Butscher
<b>Total Attachments: 2</b> source=12778US02_Assignment_STC#page1.tif source=12778US02_Assignment_STC#page2.tif	

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**PATENT**  
**REEL: 025883 FRAME: 0061**

Express Mail No. EL 542917415 US

Application:

Docket No. 12778US01{PRIVATE }

Serial No.: \_\_\_\_\_

Filing Date: \_\_\_\_\_

### ASSIGNMENT

I am the inventor whose name and residence is listed below:

**Anthony J. Saliba**, a resident of the City of Chicago, State of Illinois, and Country of United States.

I have made an invention comprising certain new, useful, and nonobvious improvements in a

#### **Method and Apparatus for Stock and Index Option Price Improvement, Participation, and Internalization**

Said invention is described or intended to be described and set forth in the patent application presently identified as Docket No. 12778US01 in the offices of McAndrews, Held & Malloy, Ltd., which I have executed on the same date(s) as I signed this assignment for the purpose of seeking Letters Patent of the United States for my invention.

**STC, L.L.C.**, a limited liability company organized and existing under and by virtue of the laws of the State of Illinois and having a place of business at 311 S. Wacker Drive, Suite 3800, Chicago IL, U.S.A., desires to acquire the entire right, title, and interest in and to said invention, said application, and any Letters Patent which may be granted for said invention, said application, and any and all divisions, continuations, continuations-in-part, reissues, reexamination certificates, and extensions thereof.

I warrant and represent that I conceived said invention, that no one other than me is the inventor of said invention, and that I have not assigned or agreed to assign any rights in said invention or said application to anyone other than said assignee or a predecessor in interest to said assignee.

I hereby authorize and request the attorneys of record for the application to insert in this assignment the filing date and serial number of said application when officially known.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to assignee, its successors and assigns, the entire worldwide right, title, and interest in and to said invention, said application, and any Letters Patent which may be granted for said invention, said


application, and any and all divisions, continuations, continuations-in-part, reissues, reexamination certificates, substitutes, and extensions of said application (each of which is included herein as a part of "said application"), including but not limited to the United States and other national rights to said invention and said application and all our rights under the Paris Convention for the Protection of Industrial Property and all other applicable treaties or laws in respect to said invention and said application.

I hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any Letters Patent that may be granted for said invention or upon said application unto said assignees, their successors and assigns, in accordance with this assignment.

I hereby authorize said assignee to apply for patents on said invention in foreign countries, claiming the filing date of said application under the provisions of the Paris Convention for the Protection of Industrial Property and all other applicable treatise and laws, and I further agree to execute any and all documents that may be required or desired by said assignees in order that said assignees may apply for Letters Patent on said invention in foreign countries in our or its name.

I hereby agree to promptly communicate to said assignee or their representatives any facts known to me respecting said invention or said application; to testify in any legal proceeding relating thereto; to sign all lawful papers, including but not limited to all divisional, continuing, continuing-in-part, reissue, substitute, and extension applications, all rightful oaths or declarations, and documents confirming or substituting for this assignment.

Signed at 311 S. Wacker Drive, Chicago IL 60606, in the County of Cook and State of Illinois, this 21st day of July, 2000.

  
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Anthony J. Saliba